

## N-Channel Enhancement Mode Power MOSFET

### Description

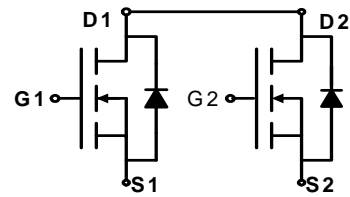
The PE8200 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications .

### General Features

- $V_{DS} = 20V, I_D = 12A$   
 $R_{DS(ON)} < 10m\Omega @ V_{GS}=4.5V$   
 $R_{DS(ON)} < 13m\Omega @ V_{GS}=2.5V$
- High power and current handling capability
- Lead free product is acquired
- Surface mount package

### Application

- Uni-directional load switch
- Bi-directional load switch



Schematic diagram



Marking and pin assignment



TSSOP-8 top view

### Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

| Parameter  | Symbol         | Limit      | Unit       |
|--|----------------|------------|------------|
| Drain-Source Voltage                             | $V_{DS}$       | 20         | V          |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 12$   | V          |
| Drain Current-Continuous                         | $I_D$          | 12         | A          |
| Drain Current-Pulsed <sup>(Note 1)</sup>         | $I_{DM}$       | 35         | A          |
| Maximum Power Dissipation                        | $P_D$          | 2          | W          |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 To 150 | $^\circ C$ |

### Thermal Characteristic

|   |                 |      |              |
|---|-----------------|------|--------------|
| Thermal Resistance, Junction-to-Ambient <sup>(Note 2)</sup> | $R_{\theta JA}$ | 62.5 | $^\circ C/W$ |
|---|-----------------|------|--------------|

### Electrical Characteristics ( $T_A=25^\circ C$ unless otherwise noted)

| Parameter                       | Symbol     | Condition                 | Min | Typ | Max | Unit    |
|---------------------------------|------------|---------------------------|-----|-----|-----|---------|
| <b>Off Characteristics</b>      |            |                           |     |     |     |         |
| Drain-Source Breakdown Voltage  | $BV_{DSS}$ | $V_{GS}=0V, I_D=250\mu A$ | 20  |     |     | V       |
| Zero Gate Voltage Drain Current | $I_{DSS}$  | $V_{DS}=20V, V_{GS}=0V$   | -   | -   | 1   | $\mu A$ |

| Parameter  | Symbol       | Condition  | Min | Typ  | Max       | Unit       |
|--|--------------|--|-----|------|-----------|------------|
| Gate-Body Leakage Current                                | $I_{GSS}$    | $V_{GS}=\pm 10V, V_{DS}=0V$                                  | -   | -    | $\pm 100$ | nA         |
| <b>On Characteristics</b> <small>(Note 3)</small>        |              |  |     |      |           |            |
| Gate Threshold Voltage                                   | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$                                | 0.5 | 0.7  | 1.0       | V          |
| Drain-Source On-State Resistance                         | $R_{DS(ON)}$ | $V_{GS}=4.5V, I_D=5A$  | -   | 8    | 10        | m $\Omega$ |
|  |              | $V_{GS}=2.5V, I_D=4A$  | -   | 10   | 13        | m $\Omega$ |
| Forward Transconductance                                 | $g_{FS}$     | $V_{DS}=5V, I_D=8A$  | -   | 15   | -         | S          |
| <b>Dynamic Characteristics</b> <small>(Note4)</small>    |              |  |     |      |           |            |
| Input Capacitance  | $C_{ISS}$    | $V_{DS}=10V, V_{GS}=0V,$<br>$F=1.0MHz$                       | -   | 1800 | -         | PF         |
| Output Capacitance                                       | $C_{OSS}$    |  | -   | 230  | -         | PF         |
| Reverse Transfer Capacitance                             | $C_{RSS}$    |  | -   | 200  | -         | PF         |
| <b>Switching Characteristics</b> <small>(Note 4)</small> |              |  |     |      |           |            |
| Turn-on Delay Time                                       | $t_{d(on)}$  | $V_{DD}=10V, R_L=1.2\Omega$<br>$V_{GS}=10V, R_{GEN}=3\Omega$ | -   | 2.5  |           | nS         |
| Turn-on Rise Time  | $t_r$        |  | -   | 7.2  |           | nS         |
| Turn-Off Delay Time                                      | $t_{d(off)}$ |  | -   | 49   |           | nS         |
| Turn-Off Fall Time                                       | $t_f$        |  | -   | 10.8 |           | nS         |
| Total Gate Charge  | $Q_g$        | $V_{DS}=10V, I_D=8A,$<br>$V_{GS}=4.5V$                       | -   | 17.9 |           | nC         |
| Gate-Source Charge                                       | $Q_{gs}$     |  | -   | 1.5  | -         | nC         |
| Gate-Drain Charge  | $Q_{gd}$     |  | -   | 4.7  | -         | nC         |
| <b>Drain-Source Diode Characteristics</b>                |              |  |     |      |           |            |
| Diode Forward Voltage <small>(Note 3)</small>            | $V_{SD}$     | $V_{GS}=0V, I_S=1A$  | -   | -    | 1.2       | V          |
| Diode Forward Current <small>(Note 2)</small>            | $I_S$        |  | -   | -    | 12        | A          |

**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production

Typical Electrical and Thermal Characteristics

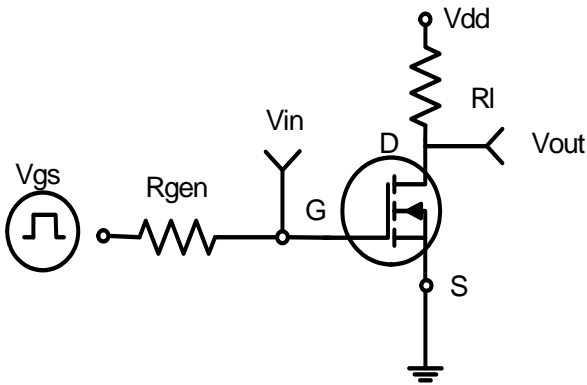


Figure 1: Switching Test Circuit

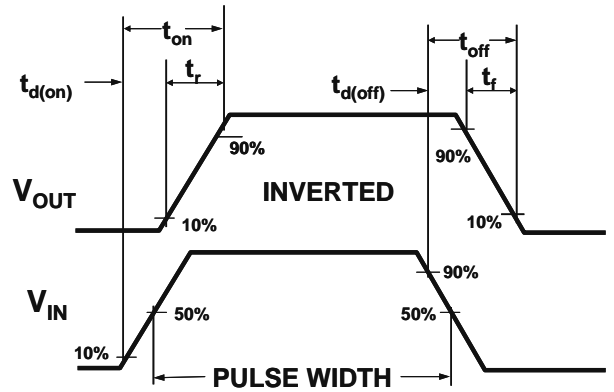


Figure 2: Switching Waveforms

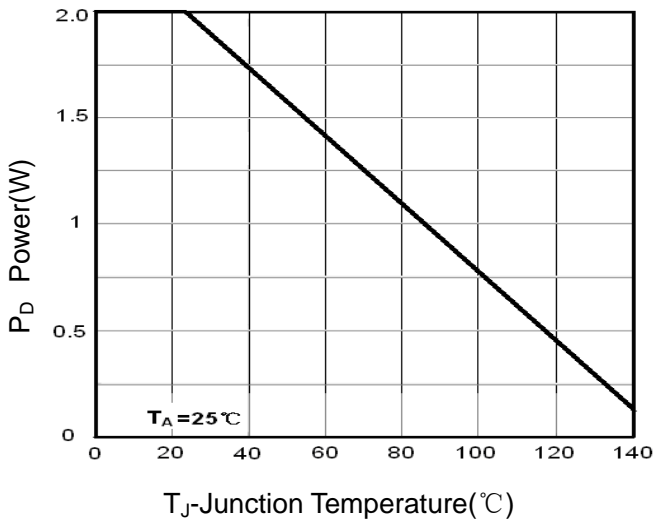


Figure 3 Power Dissipation

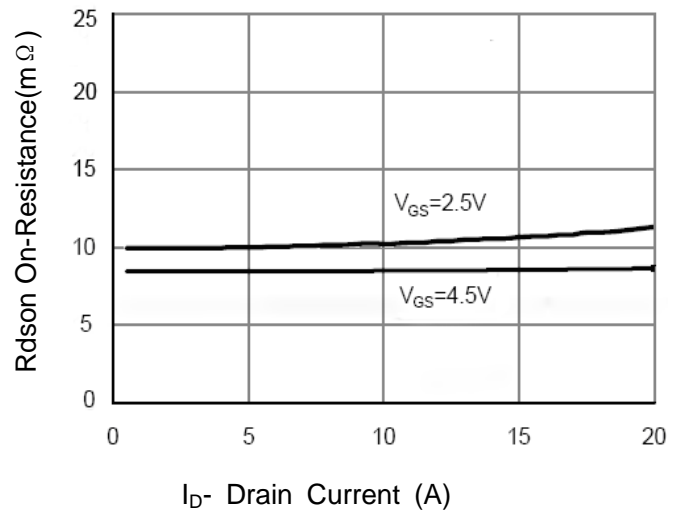


Figure 6 Drain-Source On-Resistance

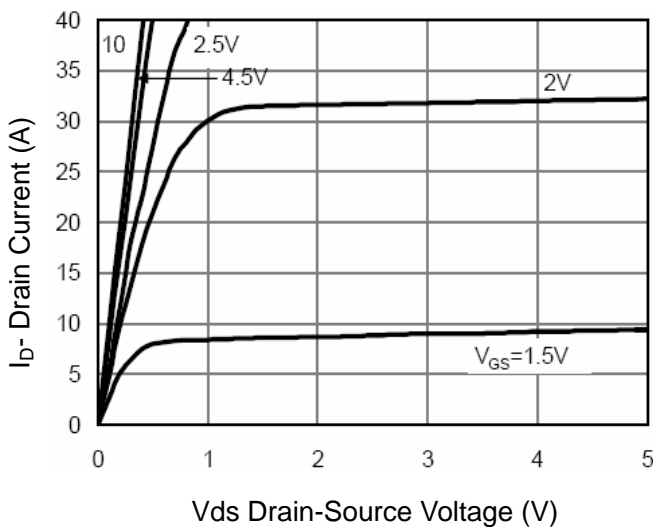


Figure 5 Output Characteristics

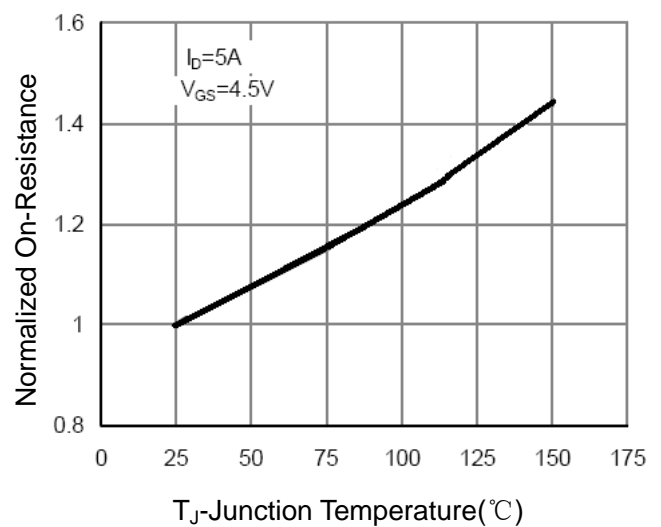
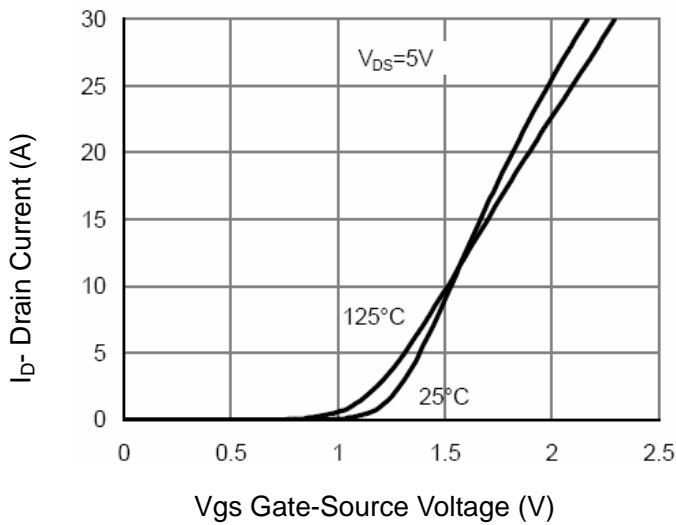
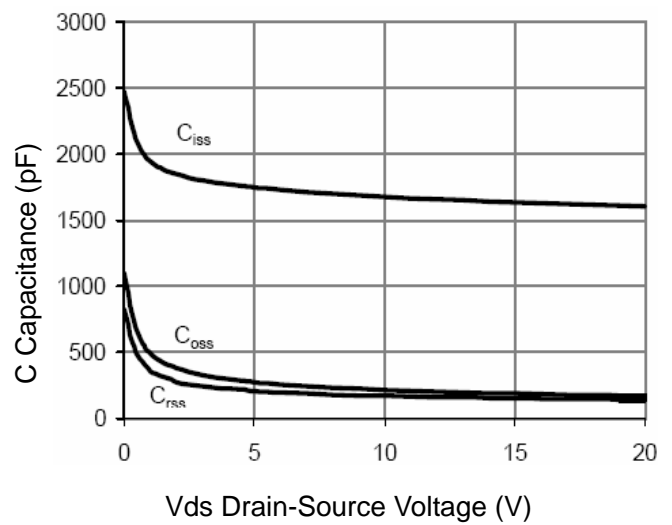


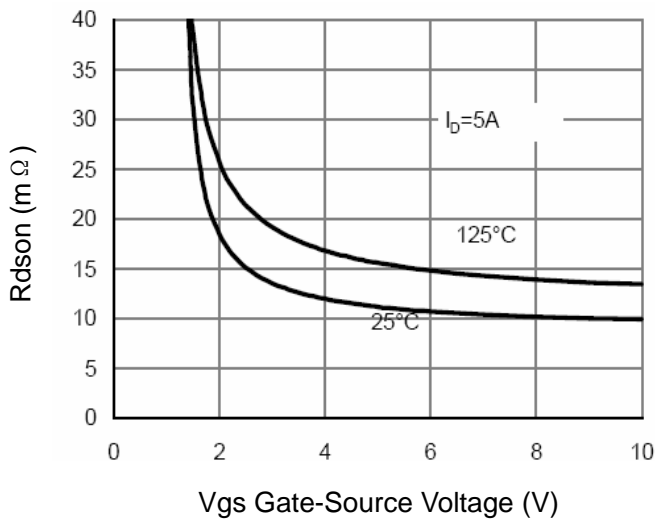
Figure 8 Drain-Source On-Resistance



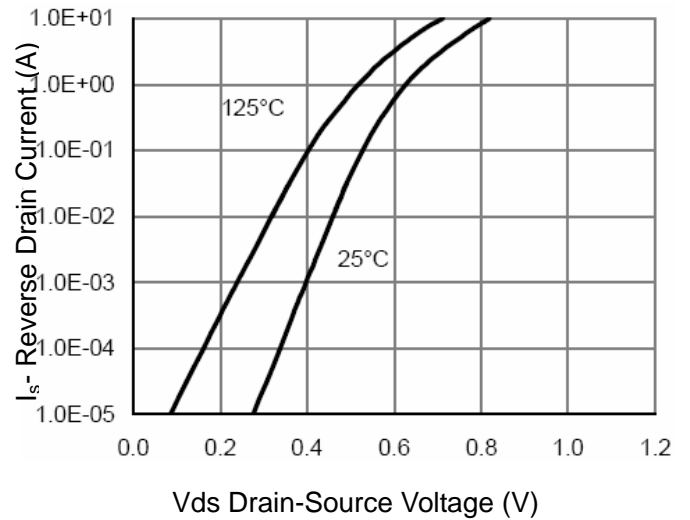
**Figure 7 Transfer Characteristics**



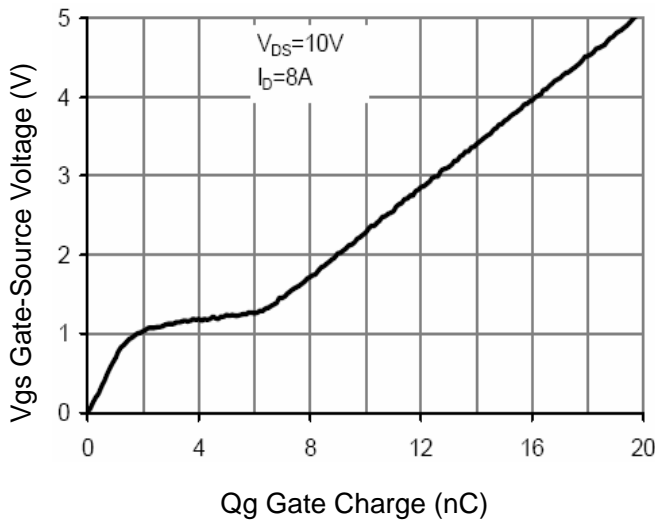
**Figure 8 Capacitance vs Vds**



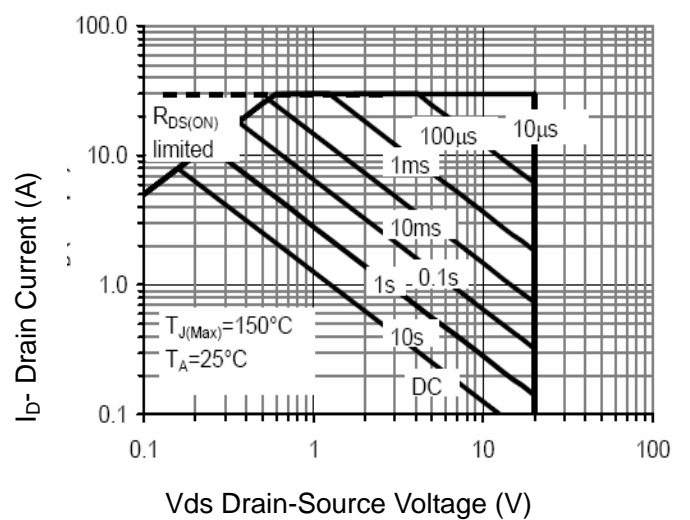
**Figure 9 Rdson vs Vgs**



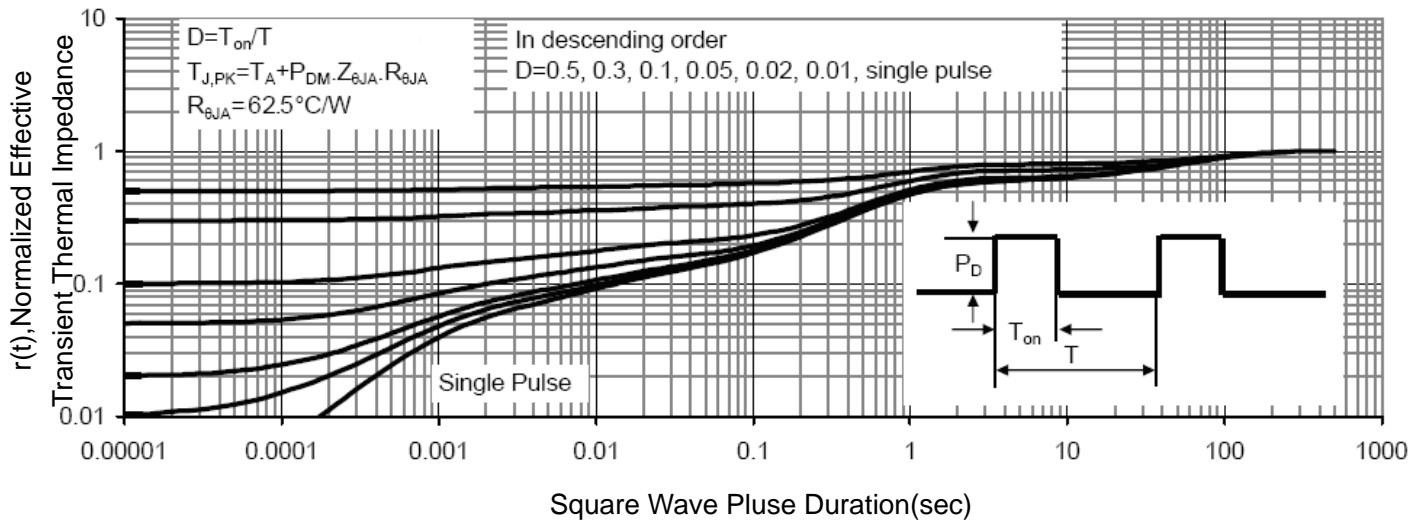
**Figure 10 Source-Drain Diode Forward**



**Figure 11 Gate Charge**

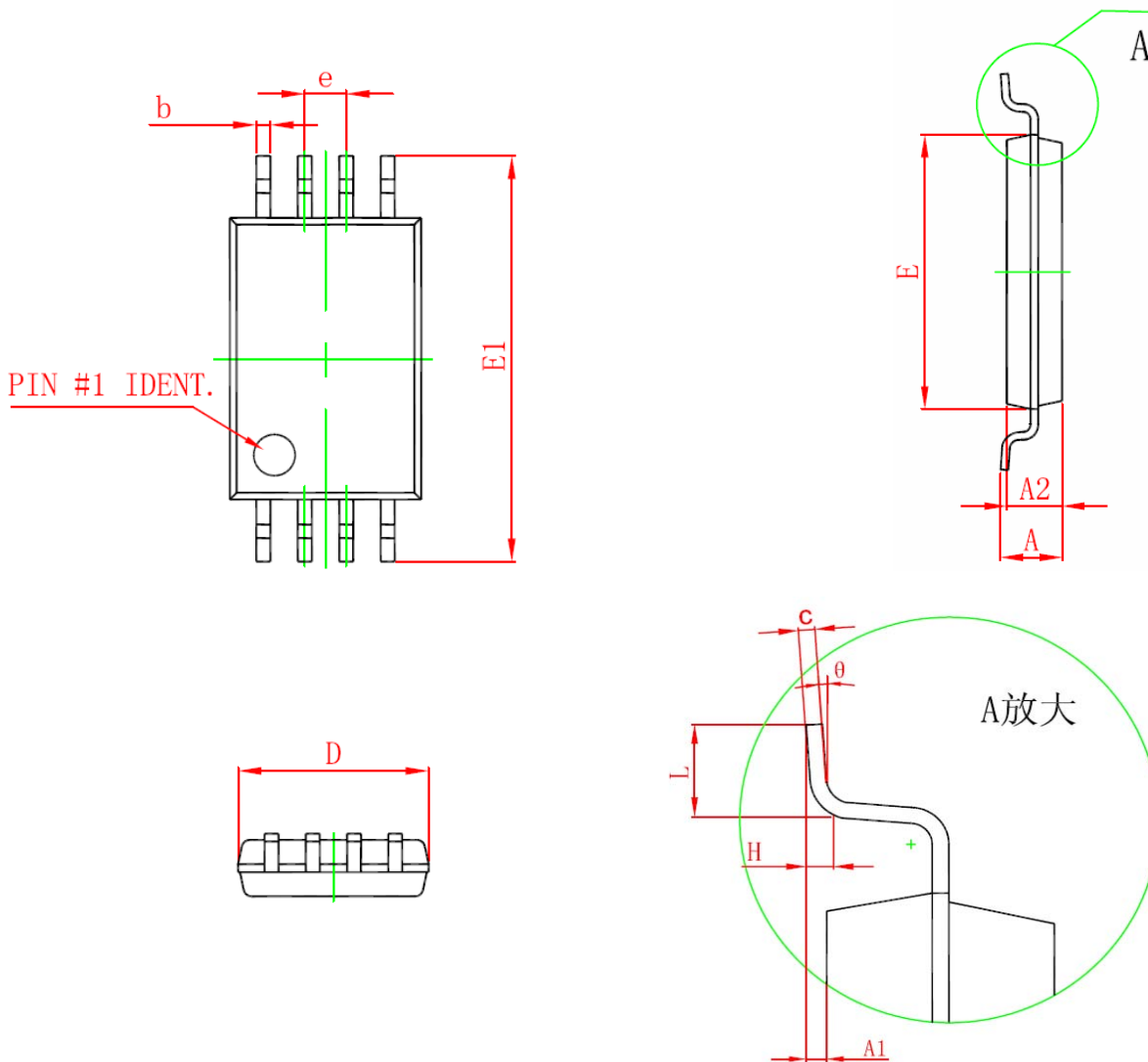


**Figure 13 Safe Operation Area**



**Figure 14 Normalized Maximum Transient Thermal Impedance**

TSSOP-8 Package Information



| Symbol   | Dimensions In Millimeters |       |
|----------|---------------------------|-------|
|          | Min                       | Max   |
| D        | 2.900                     | 3.100 |
| E        | 4.300                     | 4.500 |
| b        | 0.190                     | 0.300 |
| c        | 0.090                     | 0.200 |
| E1       | 6.250                     | 6.550 |
| A        |                           | 1.100 |
| A2       | 0.800                     | 1.000 |
| A1       | 0.020                     | 0.150 |
| e        | 0.65(BSC)                 |       |
| L        | 0.500                     | 0.700 |
| H        | 0.25(TYP)                 |       |
| $\theta$ | 1°                        | 7°    |